

THE DGD2117/2118 IS NOT RECOMMENDED FOR NEW DESIGNS. PLEASE CONTACT US.

SINGLE CHANNEL GATE DRIVER

Description

The DGD2117 and DGD2118 are high-voltage/high-speed gate drivers capable of driving one n-channel MOSFET or IGBT in a bootstrap configuration. High-voltage processing techniques enable the DGD2117 and DGD2118 to switch at 600V.

The DGD2117 and DGD2118 logic inputs are compatible with standard CMOS outputs. The driver outputs feature high pulse current buffers designed for minimum driver cross conduction. The single floating channel can be used in high-side and low-side configuration.

The DGD2117 and DGD2118 are offered in SO-8 (Type TH) package and the operating temperature extends from -40°C to +125°C.

Features

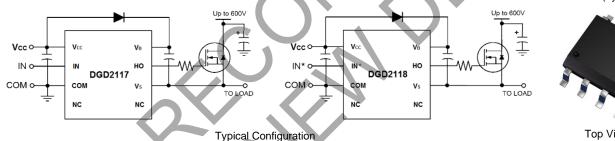
- Floating Channel in Bootstrap Operation to 600V
- Drives One N-Channel MOSFET or IGBT
- **Outputs Tolerant to Negative Transients**
- Wide Logic Supply: 10V to 20V
- Schmitt Triggered Logic Input with Internal Pulldown
- Undervoltage Lockout
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Applications

- DC-DC converters
- DC-AC inverters
- AC-DC power supplies
- Motor controls
- Class D power amplifiers

Mechanical Data

- Package: SO-8
- Package Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.075 grams (Approximate)







Top View

Ordering Information (Note 4)

Part Number Package		Marking Reel Size (inches)		Tape Width (mm)	Packing	
rait Number	Fackage	Warking	Reel Size (Illiches)	rape widin (ililii)	Qty.	Carrier
DGD2117S8-13	SO-8 (Type TH)	DGD2117	13	12	2,500	Reel
DGD2118S8-13	SO-8 (Type TH)	DGD2118	13	12	2,500	Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

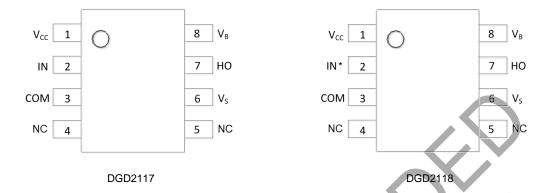
Marking Information



⊃¦¦ = Manufacturer's Marking DGD211x = Product Type Marking Code (See Table Above) YY = Year (ex: 24 = 2024)WW = Week (01 to 53)



Pin Diagrams

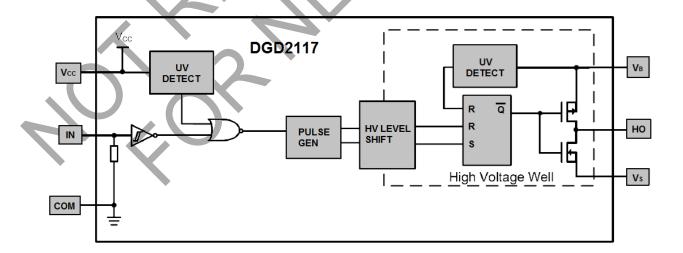


Top View SO-8 (Type TH)

Pin Descriptions

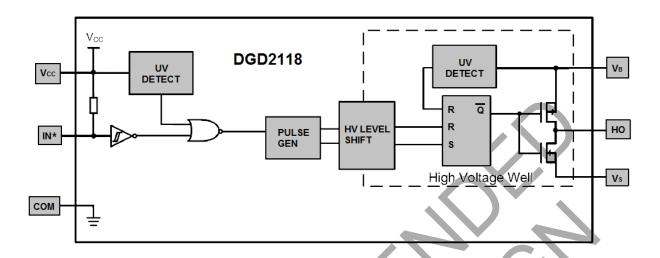
Pin Number	Pin Name	Function
1	Vcc	Logic and gate driver supply
2	IN	DGD2117 Logic input for gate driver output (HO), in phase with HO
2	IN*	DGD2118 Logic input for gate driver output (HO), out of phase with HO
3	COM	Logic ground
4, 5	NC	No connection (No internal connection)
6	Vs	High-side floating supply return
7	НО	High-side gate drive output
8	VB	High-side floating supply

Functional Block Diagram





Functional Block Diagram (continued)



Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Supply Voltage	V_{B}	-0.3 to +624	V
High-Side Floating Supply Offset Voltage	Vs	V _B -24 to V _B +0.3	V
High-Side Floating Output Voltage	Vно	Vs-0.3 to V _B +0.3	V
Logic Supply Voltage	Vcc	-0.3 to +24	V
Logic Input Voltage	Vin	-0.3 to Vcc+0.3	V
Allowable Offset Supply Voltage Transient	dVs/dt	50	V/ns

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	PD	0.625	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	45	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	T∟	+300	°C
Storage Temperature Range	T _{STG}	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage	VB	Vs + 10	Vs + 20	V
High Side Floating Supply Offset Voltage	Vs	(Note 6)	600	V
High Side Floating Output Voltage	V _{HO}	Vs	V _B	V
Low Side and Logic Fixed Supply Voltage	Vcc	10	20	V
Logic Input Voltage	Vin	0	Vcc	V
Ambient Temperature	T _A	-40	+125	°C

Note: 6. Logic operation for $V_S = -5V$ to +600V.



DC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, @T_A = +25°C, unless otherwise specified.) (Note 7)

Parameter		Symbol	Min	Тур	Max	Unit	Conditions
Logic "1" (DGD2117) & Logic "0" (DGD2118) Input Voltage (Note 8)		ViH	9.5	_	_	V	_
Logic "0" (DGD2117) & Logic "1" (DGD2118) Input Voltage (Note 8)		VIL			6.0	V	_
High-Level Output Voltage, VBIAS - VO		Vон	_	0.05	0.2	٧	I _O = 2mA
Low-Level Output Voltage, Vo		V _{OL}	ı	0.02	0.1	V	$I_O = 2mA$
Offset Supply Leakage Current		ILK	ı		50	μΑ	V _B = V _S = 600V
Quiescent V _{BS} Supply Current		I _{BSQ}	-	50	240	μΑ	Vin = 0V or Vcc
Quiescent V _{CC} Supply Current		Iccq		70	340	μΑ	$V_{IN} = 0V \text{ or } V_{CC}$
Logic "1" Input Bias Current	DGD2117	I.u.		20	40		Vin = Vcc
Logic 1 Input Bias Current	DGD2118	lin+		20	4	μA	$V_{IN} = 0V$
Logic "0" Input Bias Current	DGD2117	lu.			5.0	uA	VIN = 0V
Logic o Input Bias Current	DGD2118	I _{IN} -			3.0	μζ	$V_{IN} = V_{CC}$
V _{BS} Supply Undervoltage Positive Goi	ng Threshold	V _{BSUV+}	7.6	8.6	9.6	>	_
V _{BS} Supply Undervoltage Negative Go	ing Threshold	VBSUV-	7.2	8.2	9.2	V	
V _{CC} Supply Undervoltage Positive Going Threshold		V _{CCUV+}	7.6	8.6	9.6	V	
V _{CC} Supply Undervoltage Negative Going Threshold		Vccuv-	7.2	8.2	9.2	V	_
Output High Short-Circuit Pulsed Current		lo+	200	290		mA	$V_O = 0V$, $V_{IN} = Logic "1"$ $P_W \le 10\mu s$
Output Low Short-Circuit Pulsed Curre	ent	lo-	420	600		mA	Vo = 15V, V _{IN} = Logic "0" Pw ≤ 10µs

Notes:

AC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, C_L = 1000pF, @T_A = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Turn-On Propagation Delay	ton	1	125	200	ns	Vs = 0V
Turn-Off Propagation Delay	toff	4	105	180	ns	Vs = 600V
Turn-On Rise Time	tr	_	75	130	ns	_
Turn-Off Fall Time	tr		35	65	ns	_

^{7.} The V_{IN} and I_{IN} parameters are referenced to COM and are applicable to the logic input pins: IN and IN*. The V_O and I_O parameters are referenced to COM

and are applicable to the output pin: HO.

8. For optimal operation, it is recommended that the input pulses (IN and IN*) should have a minimum amplitude of 9.5V with a minimum pulse width of



Timing Waveforms

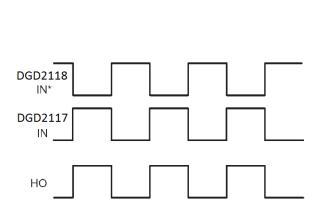


Figure 1. Input / Output Timing Diagram

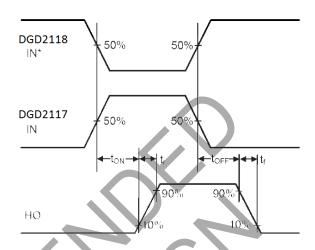


Figure 2. Switching Time Waveform Definitions



Typical Performance Characteristics (V_{CC} = 15V, @T_A = +25°C, unless otherwise specified.)

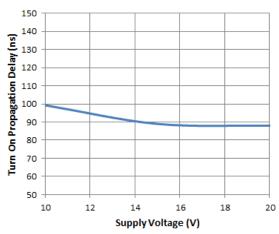


Figure 3. Turn-on Propagation Delay vs. Supply Voltage

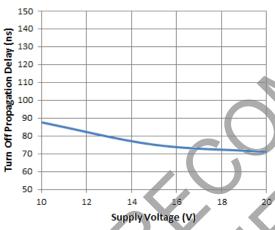


Figure 5. Turn-off Propagation Delay vs. Supply Voltage

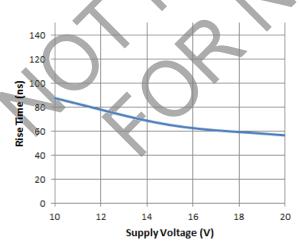


Figure 7. Rise Time vs. Supply Voltage

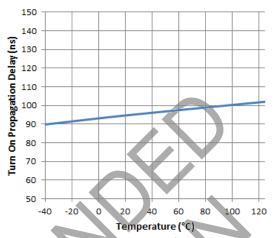


Figure 4. Turn-on Propagation Delay vs. Temperature

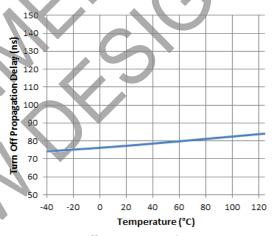


Figure 6. Turn-off Propagation Delay vs. Temperature

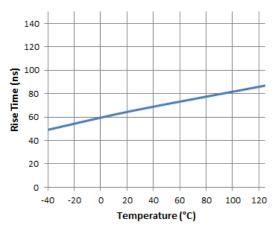


Figure 8. Rise Time vs. Temperature



Typical Performance Characteristics (V_{CC} = 15V, @T_A = +25°C, unless otherwise specified.) (continued)

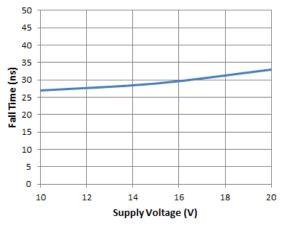


Figure 9. Fall Time vs. Supply Voltage

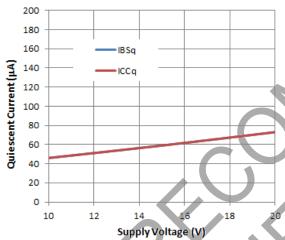


Figure 11. Quiescent Current vs. Supply Voltage



Figure 13. Output Source Current vs. Supply Voltage

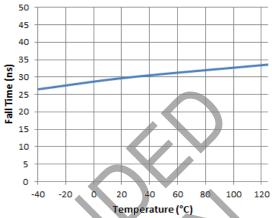


Figure 10. Fall Time vs. Temperature

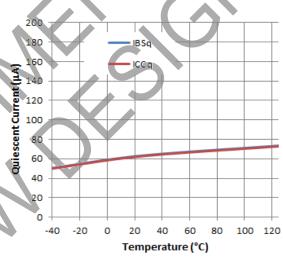


Figure 12. Quiescent Current vs. Temperature

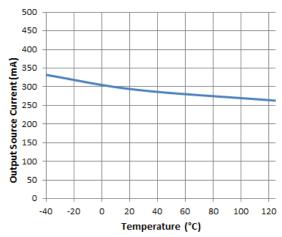


Figure 14. Output Source Current vs. Temperature



Typical Performance Characteristics (V_{CC} = 15V, @T_A = +25°C, unless otherwise specified.) (continued)

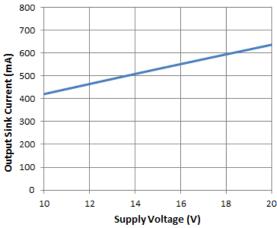


Figure 15. Output Sink Current vs. Supply Voltage

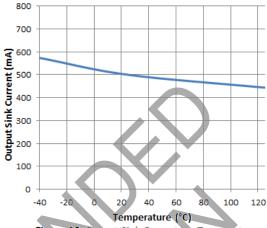


Figure 16. Output Sink Current vs. Temperature

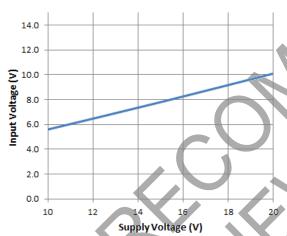


Figure 17. DGD2117 Logic 1 (DGD2118 Logic 0) Input Voltage vs. Supply Voltage

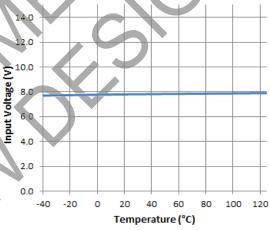


Figure 18. DGD2117 Logic 1 (DGD2118 Logic 0) Input Voltage vs. Temperature

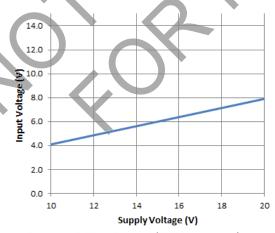


Figure 19. DGD2117 Logic 0 (DGD2118 Logic 1) Input Voltage vs. Supply Voltage

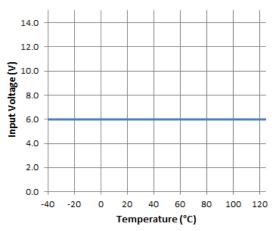


Figure 20. DGD2117 Logic 0 (DGD2118 Logic 1)
Input Voltage vs. Temperature



Typical Performance Characteristics (V_{CC} = 15V, @T_A = +25°C, unless otherwise specified.) (continued)

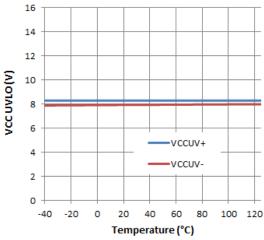


Figure 21. VCC UVLO vs. Temperature

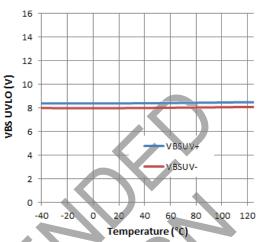


Figure 22. VBS UVLOws. Temperature

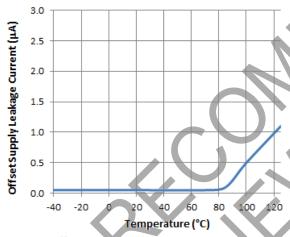


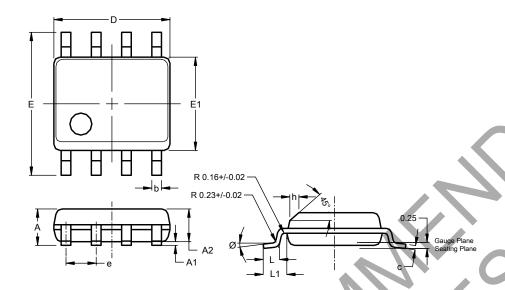
Figure 23. Offset Supply Leakage Current vs. Temperature



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8 (Type TH)

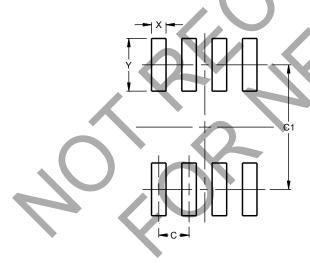


,	SO-8 (Type TH)						
Dim	Min	Max	Тур				
Α	1.35	1.75					
A1_	0.10	0.25					
A2			1.45				
b	0.35	0.51					
С	0.190	0.248					
D	D 4.80		4.90				
E	5.80	6.20	6.00				
E1	3.80	4.00	3.90				
е			1.27				
h	0.25	0.50					
L	0.41	1.27					
L1			1.04				
Ø	0°	8°					
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8 (Type TH)



Dimensions	Value (in mm)
C	1.27
C1	5.20
Х	0.60
Y	2.20

Note: 9. For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



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